

DESCRIPTION

The YXD2300NE1 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and high density cell Design for ultra low on-resistance. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- ◆ $V_{DS} = 20V$, $I_D = 4A$
- $R_{DS(ON)}(\text{Typ.}) = 26m\Omega$ @ $V_{GS} = 2.5V$
- $R_{DS(ON)}(\text{Typ.}) = 21.5m\Omega$ @ $V_{GS} = 4.5V$
- ◆ High power and current handing capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

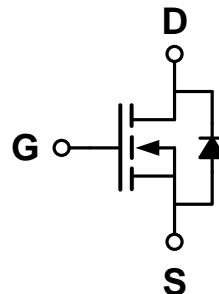
APPLICATION

- ◆ PWM applications
- ◆ Load switch

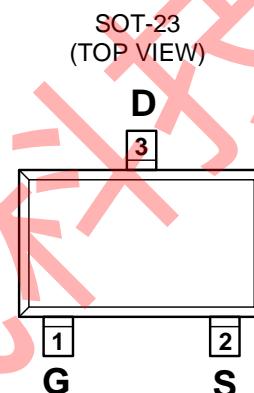
PACKAGE

- ◆ SOT-23

SCHEMATIC DIAGRAM



PIN ASSIGNMENT



ORDERING INFORMATION

Part Number	Storage Temperature	Package	Marking	Devices Per Reel
YXD2300NE1	-55°C to +150°C	SOT-23	2300	3000

ABSOLUTE MAXIMUM RATINGS

($T_A = 25^\circ C$ unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	20	V
Gate-source voltage	V_{GS}	± 12	V
Continuous drain current ($T_J = 150^\circ C$) ^a	I_D	4	A
		3	
Pulsed drain current ^b	I_{DM}	12	
Continuous source current (diode conduction) ^a	I_S	1.4	
Power dissipation ^a	P_D	1.7	W
		1.1	
Operating junction and storage temperature range	T_J, T_{stg}	-55—150	°C

THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Max	Unit
Maximum junction-to-ambient ^a	≤ 5 s	$R_{\theta JA}$	120	145
	Steady-State		140	175
Maximum junction-to-foot	Steady-State	$R_{\theta JC}$	62	78

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Pulse width limited by maximum junction temperature

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

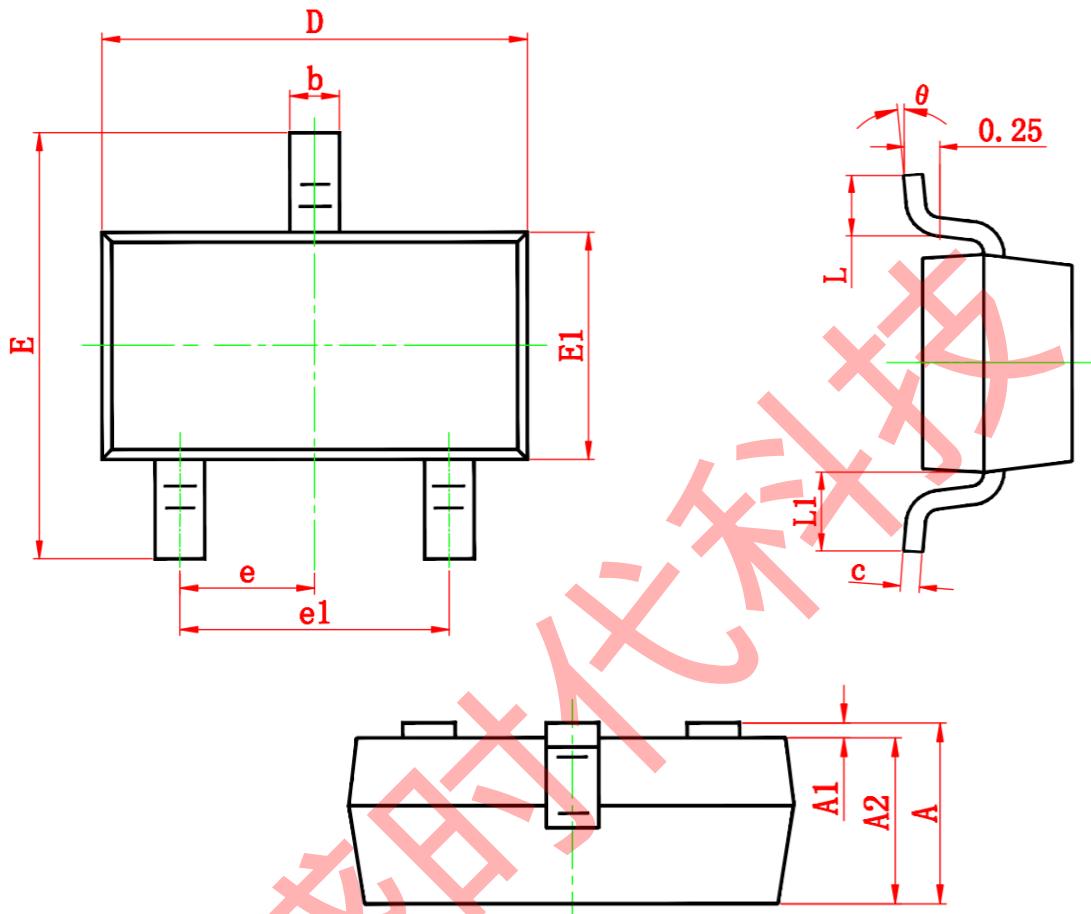
Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	20	-	-	V
Zero gate voltage drain current	I_{DSs}	$V_{DS}=20V, V_{GS}=0V$	-	-	1	μA
Gate-body leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$	-	-	± 100	nA
ON Characteristics						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.6	1.0	V
Drain-source on-state resistance ^a	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=4A$	-	21.5	25	$m\Omega$
		$V_{GS}=2.5V, I_D=3A$		26	32	
Forward transconductance ^a	g_f	$V_{DS}=10V, I_D=4A$	-	29	-	S
Dynamic Characteristics ^b						
Input capacitance	C_{iss}	$V_{DS}=10V, V_{GS}=0V$ $f=1.0MHz$	-	735	-	pF
Output capacitance	C_{oss}		-	110	-	
Reverse transfer capacitance	C_{rss}		-	40	-	
Switching Characteristics						
Turn-on delay time	$t_{D(ON)}$	$V_{DD}=10V$ $R_L=2.8\ ohm$ $V_{GEN}=8V$ $R_{GEN}=6ohm$	-	4	-	ns
Rise time	t_r		-	22	-	
Turn-off delay time	$t_{D(OFF)}$		-	16	-	
Fall time	t_f		-	9	-	
Total gate charge	Q_g	$V_{DS}=10V$ $I_D=4A$ $V_{GS}=4.5V$	-	7.7	-	nC
Gate-source charge	Q_{gs}		-	1	-	
Gate-drain charge	Q_{gd}		-	1	-	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode forward voltage	V_{SD}	$V_{GS}=0V, I_s=2.5A$	-	0.76	1.16	V

Notes

- a. Pulse test: Pulse width $\leq 300\ \mu s$, duty cycle $\leq 2\ %$
- b. Guaranteed by design, not subject to production testing

PACKAGE INFORMATION

- SOT-23



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	2.250	2.550	0.089	0.100
E1	1.200	1.400	0.047	0.055
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.300	0.500	0.012	0.020
L1	0.550 REF.		0.022 REF.	
θ	0°	8°	0°	8°

RECOMMENDED MINIMUM PADS FOR SOT-23